Surface Mount

Attenuator/Switch

RAS-1+

50Ω Bi-Phase 2 to 400 MHz

Generic photo used for illustration purposes only

CASE STYLE: TT241

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Maximum Ratings

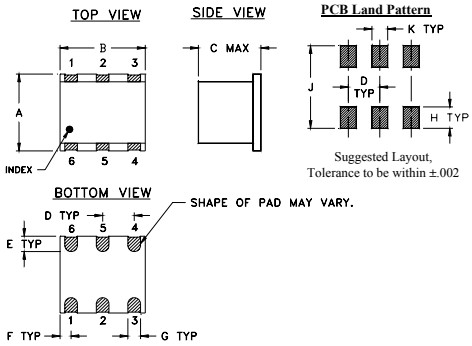
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
Control Current	30mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

INPUT	4
OUTPUT	1
CONTROL	5
GROUND	2,3,6

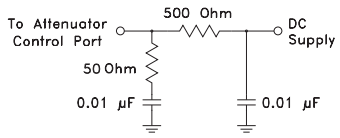
Outline Drawing



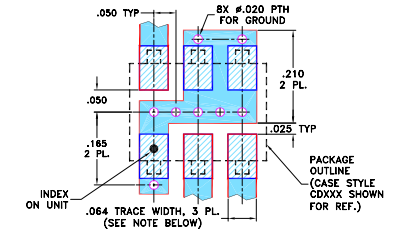
Outline Dimensions (inch / mm)

A	B	C	D	E	F
.250	.31	.275	.100	.050	.055
6.35	7.87	6.99	2.54	1.27	1.40
G	**H**	**J**	**K**		**wt**
.040	.070	.270	.050		grams
1.02	1.78	6.86	1.27		0.50

suggested control port biasing configuration



Demo Board MCL P/N: TB-03
Suggested PCB Layout (PL-052)



NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- wideband, 2 to 400 MHz
- low conversion loss, 1.6 dB typ.
- excellent phase and amplitude unbalance

Applications

- bi-phase modulator

Attenuator/Switch Electrical Specifications

FREQUENCY (MHz)		INSERTION LOSS (dB) ±20 mA				MAX. INPUT PWR (dBm) ±20 mA		IN-OUT ISOLATION (dB) 0 mA						BI-PHASE $\overline{X}$ (±20 mA) Typ.			
		Mid-Band m		Total Range				L		M		U		Δ AMP (dB)		Phase (deg.) deviation from 180°	
IN f_L-f_U	CON	Typ.	Max.	Typ.	Max.	1 dB compr.	no damage	Typ.	Min.	Typ.	Min.	Typ.	Min.	m	Total Range	m	Total Range
2-400	DC-0.05	1.4	2.4	1.6	3.2	20*	25	65	45	45	28	32	22	0.10	0.1	1.0	2.0

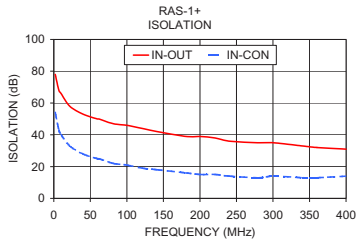
L = low range [f_L to 10 f_L] M = mid range [10 f_L to f_U/2] U = upper range [f_U/2 to f_U] m = [2 f_L to f_U/2]

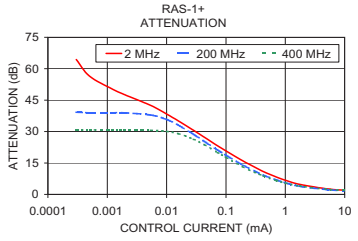
* 15 dBm from 2-10 MHz.

Performance specifications apply for input power up to 10 dB below stated 1 dB compression.

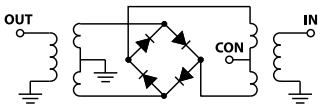
Typical Performance Data

Freq. (MHz)	I. Loss (dB) at 20mA		±Control ΔΔAMP (dB)	20mA ΔΔPhase (deg.)	Isolation (dB) (in-out)	Isolation (dB) (in-con)	Input R. Loss (dB)	Control Current (mA)	Attenuation (dB)			Phase Δ ref at 15mA Ctrl			Input VSWR		
									2 MHz	200 MHz	400 MHz	2 MHz deg.	200 MHz deg.	400 MHz deg.	2 MHz	200 MHz	400 MHz
	$\overline{x}$	σ	$\overline{x}$	$\overline{x}$	$\overline{x}$	$\overline{x}$	$\overline{x}$										
2.0	1.67	0.000	0.01	179.9	78	54	18.1	0.0000	72.7	39.0	30.6	27.2	-87.7	-95.3	7.7	7.2	4.4
7.0	1.16	0.001	0.00	180.0	68	43	15.4	0.0003	64.4	39.2	30.7	22.2	-86.0	-94.6	7.7	7.2	4.4
10.0	1.16	0.001	0.00	180.0	66	40	27.6	0.0005	56.5	39.0	30.8	28.6	-84.3	-93.7	7.6	7.2	4.4
21.9	1.16	0.001	0.00	180.0	58	33	31.0	0.0012	50.4	39.0	30.7	17.6	-80.5	-92.0	7.6	7.2	4.4
39.8	1.19	0.001	0.00	180.1	53	28	31.9	0.0019	47.8	39.0	30.7	14.1	-77.4	-90.3	7.5	7.2	4.4
59.7	1.23	0.001	0.00	180.1	50	25	32.1	0.0054	42.5	37.9	30.6	8.2	-56.2	-79.9	7.4	7.0	4.3
61.7	1.23	0.001	0.00	180.1	50	25	32.1	0.0100	38.4	35.8	30.1	7.6	-37.3	-67.6	7.2	6.9	4.3
81.6	1.24	0.001	0.00	180.2	47	22	32.2	0.0157	35.1	33.1	29.0	8.8	-25.3	-55.1	7.1	6.7	4.2
99.5	1.27	0.001	0.00	180.2	46	21	32.3	0.0284	30.6	28.7	26.3	8.8	-12.8	-37.6	6.7	6.3	4.0
121.4	1.31	0.001	0.01	180.3	44	19	32.4	0.0433	27.3	25.3	23.7	9.2	-7.2	-26.9	6.3	5.9	3.8
141.3	1.32	0.001	0.01	180.4	42	18	32.4	0.0722	23.2	21.2	20.0	9.3	-3.1	-17.7	5.6	5.3	3.5
181.1	1.37	0.001	0.01	180.6	39	16	32.2	0.1012	20.7	18.6	17.6	9.0	-1.4	-13.2	5.2	4.9	3.3
200.0	1.40	0.001	0.01	180.6	39	15	32.0	0.1898	16.1	14.1	13.3	8.2	0.4	-8.0	4.1	3.9	2.8
220.9	1.39	0.001	0.01	180.8	38	15	31.6	0.3008	13.1	11.2	10.6	7.4	0.9	-5.5	3.4	3.2	2.4
240.8	1.39	0.001	0.01	180.9	36	14	30.3	0.4259	10.9	9.2	8.8	6.7	1.1	-4.2	2.9	2.7	2.1
280.6	1.52	0.001	0.05	181.1	35	13	26.6	0.7017	8.3	6.9	6.6	5.4	1.1	-2.8	2.2	2.1	1.7
300.5	1.52	0.001	0.04	181.1	35	14	24.8	0.9968	6.8	5.6	5.4	4.4	0.9	-2.1	1.9	1.8	1.5
340.3	1.56	0.001	0.03	181.4	33	13	21.4	1.7486	4.8	3.9	4.0	3.0	0.7	-1.3	1.5	1.5	1.3
360.2	1.64	0.002	0.06	181.6	32	13	19.8	5.6920	2.5	2.1	2.3	0.9	0.2	-0.3	1.2	1.1	1.2
400.0	1.78	0.003	0.09	181.7	31	14	17.1	15.1258	1.8	1.5	1.8	0.0	0.0	0.1	1.3	1.1	1.3





electrical schematic



Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Attenuator/Switch RAS-1+

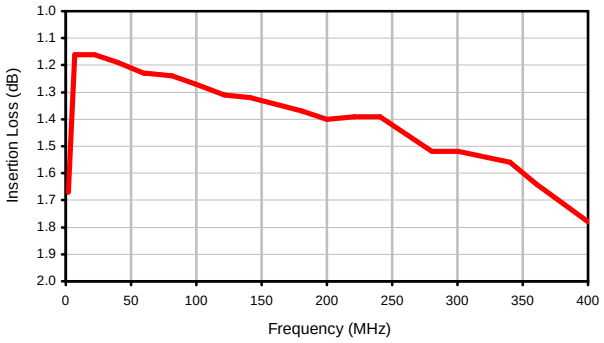
Typical Performance Data

FREQ. (MHz)	INSERTION LOSS (dB) at 20mA Control Current	AMP. UNBAL. (dB) at ± 20mA Control Current	PHASE UNBAL. (deg.) at ± 20mA Control Current	ISOLATION at 0 mA Control Current (dB) In-Out	ISOLATION at 0 mA Control Current (dB) In-Con	RETURN LOSS (dB) Input
2.0	1.67	0.01	179.9	78	54	18.1
7.0	1.16	0.00	180.0	68	43	15.4
10.0	1.16	0.00	180.0	66	40	27.6
21.9	1.16	0.00	180.0	58	33	31.0
39.8	1.19	0.00	180.1	53	28	31.9
59.7	1.23	0.00	180.1	50	25	32.1
61.7	1.23	0.00	180.1	50	25	32.1
81.6	1.24	0.00	180.2	47	22	32.2
99.5	1.27	0.00	180.2	46	21	32.3
121.4	1.31	0.01	180.3	44	19	32.4
141.3	1.32	0.01	180.4	42	18	32.4
181.1	1.37	0.01	180.6	39	16	32.2
200.0	1.40	0.01	180.6	39	15	32.0
220.9	1.39	0.01	180.8	38	15	31.6
240.8	1.39	0.01	180.9	36	14	30.3
280.6	1.52	0.05	181.1	35	13	26.6
300.5	1.52	0.04	181.1	35	14	24.8
340.3	1.56	0.03	181.4	33	13	21.4
360.2	1.64	0.06	181.6	32	13	19.8
400.0	1.78	0.09	181.7	31	14	17.1

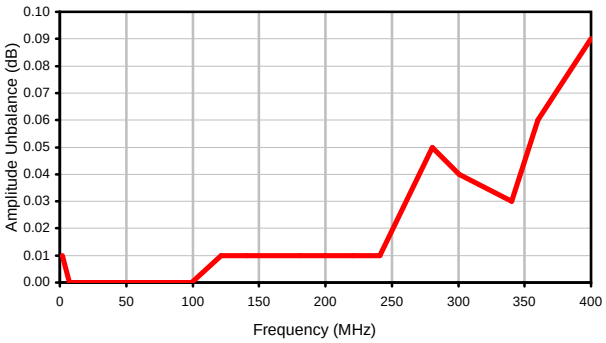
CONTROL CURRENT (mA)	ATTENUATION (dB) 2 MHz	ATTENUATION (dB) 200 MHz	ATTENUATION (dB) 400 MHz	PHASE UNBALANCE REF AT 15 mA CONTROL (deg.) 2 MHz	PHASE UNBALANCE REF AT 15 mA CONTROL (deg.) 200 MHz	PHASE UNBALANCE REF AT 15 mA CONTROL (deg.) 400 MHz	INPUT VSWR (:1) 2 MHz	INPUT VSWR (:1) 200 MHz	INPUT VSWR (:1) 400 MHz
0.0000	72.7	39.0	30.6	27.2	-87.7	-95.3	7.7	7.2	4.4
0.0003	64.4	39.2	30.7	22.2	-86.0	-94.6	7.7	7.2	4.4
0.0005	56.5	39.0	30.8	28.6	-84.3	-93.7	7.6	7.2	4.4
0.0012	50.4	39.0	30.7	17.6	-80.5	-92.0	7.6	7.2	4.4
0.0019	47.8	39.0	30.7	14.1	-77.4	-90.3	7.5	7.2	4.4
0.0054	42.5	37.9	30.6	8.2	-56.2	-79.9	7.4	7.0	4.3
0.0100	38.4	35.8	30.1	7.6	-37.3	-67.6	7.2	6.9	4.3
0.0157	35.1	33.1	29.0	8.8	-25.3	-55.1	7.1	6.7	4.2
0.0284	30.6	28.7	26.3	8.8	-12.8	-37.6	6.7	6.3	4.0
0.0433	27.3	25.3	23.7	9.2	-7.2	-26.9	6.3	5.9	3.8
0.0722	23.2	21.2	20.0	9.3	-3.1	-17.7	5.6	5.3	3.5
0.1012	20.7	18.6	17.6	9.0	-1.4	-13.2	5.2	4.9	3.3
0.1898	16.1	14.1	13.3	8.2	0.4	-8.0	4.1	3.9	2.8
0.3008	13.1	11.2	10.6	7.4	0.9	-5.5	3.4	3.2	2.4
0.4259	10.9	9.2	8.8	6.7	1.1	-4.2	2.9	2.7	2.1
0.7017	8.3	6.9	6.6	5.4	1.1	-2.8	2.2	2.1	1.7
0.9968	6.8	5.6	5.4	4.4	0.9	-2.1	1.9	1.8	1.5
1.7486	4.8	3.9	4.0	3.0	0.7	-1.3	1.5	1.5	1.3
5.6920	2.5	2.1	2.3	0.9	0.2	-0.3	1.2	1.1	1.2
15.1258	1.8	1.5	1.8	0.0	0.0	0.1	1.3	1.1	1.3

Typical Performance Curves

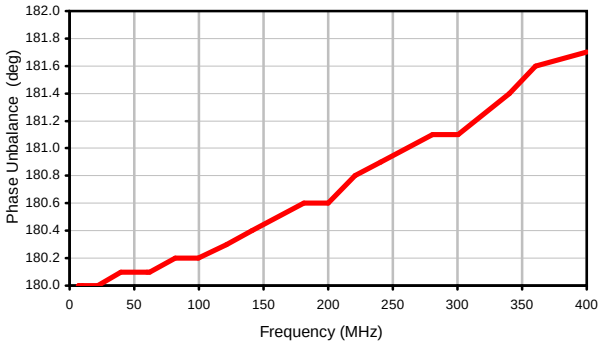
Insertion Loss @ 20 mA



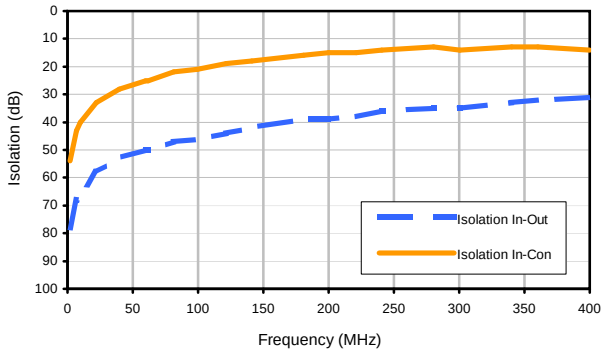
Amplitude Unbalance @ ± 20mA



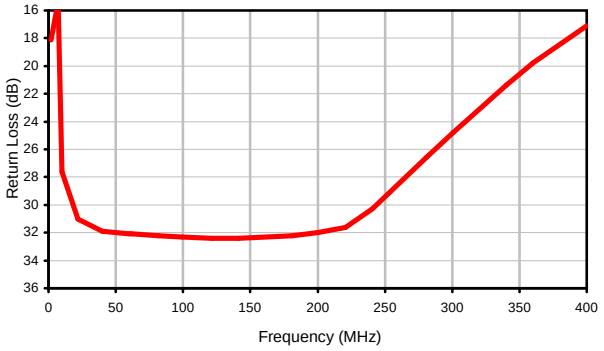
Phase Unbalance @ ± 20mA



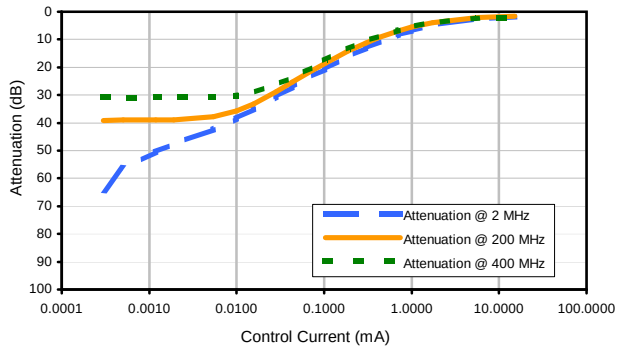
Isolation @ 0 mA



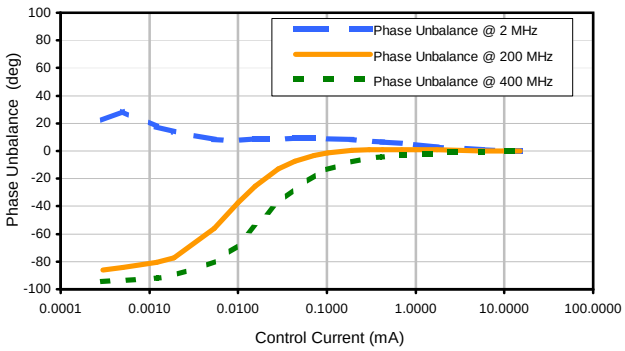
Return Loss Input



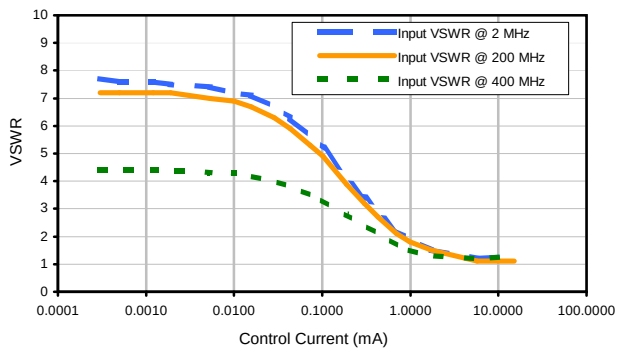
Attenuation



Phase Unbalance ref @ 15 mA



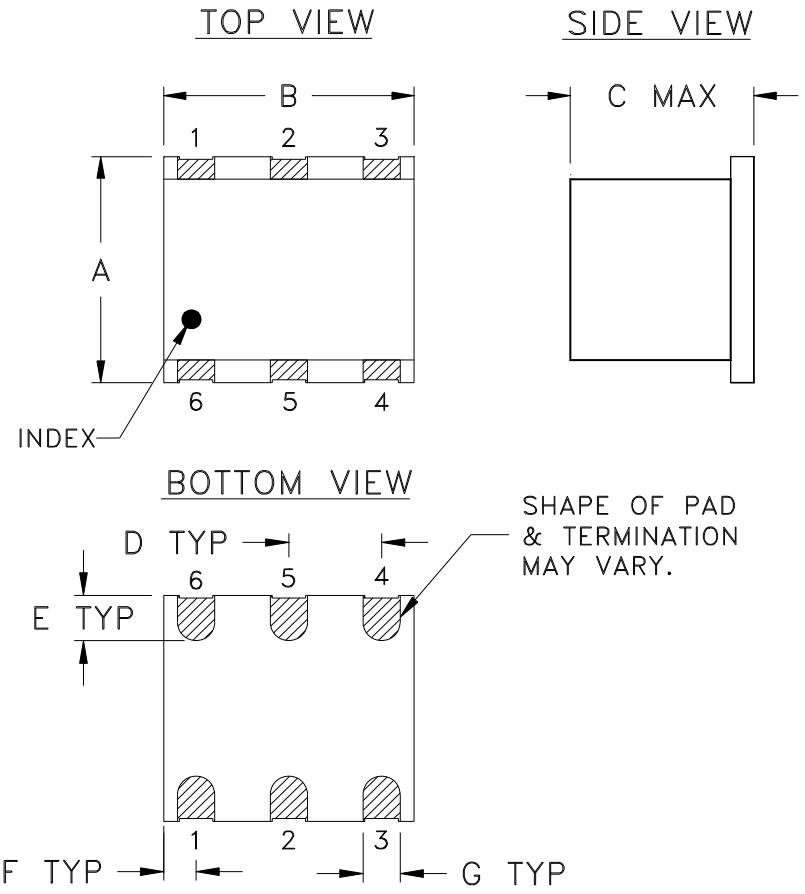
Input VSWR



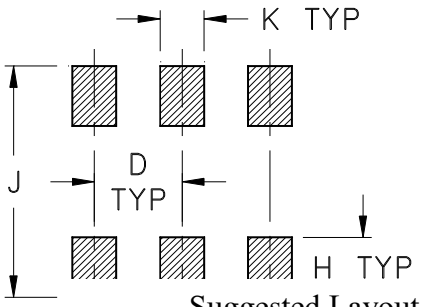
Case Style TT

TT241

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

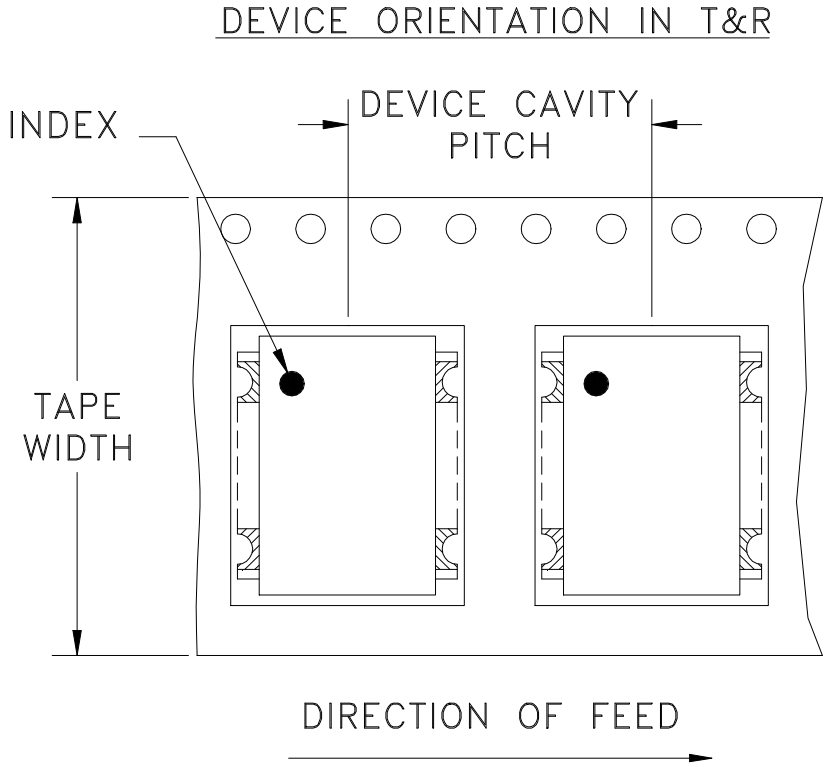
CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
TT241	.250 (6.35)	.31 (7.87)	.27 (6.99)	.100 (2.54)	.050 (1.27)	.055 (1.40)	.040 (1.02)	.070 (1.78)	.270 (6.86)	.050 (1.27)	.50

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

Notes:

1. Case material: Ceramic.
2. Termination finish:
   For RoHS Case Styles: 2-10µ inch (.05-.25 microns) Gold plate over 100-300 µ inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F50



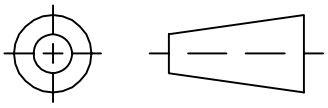
Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
24	12	13	500

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

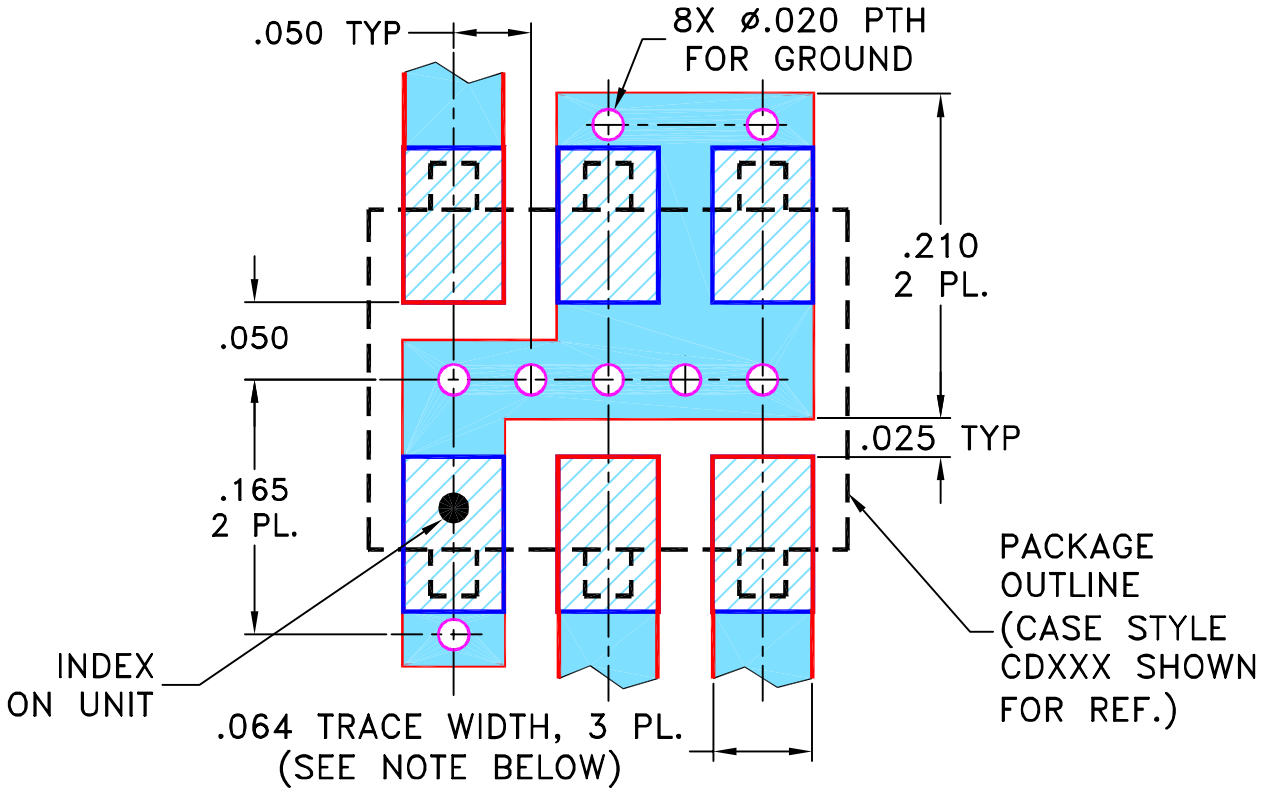
Mini-Circuits®
INTERNET http://www.minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010
Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION



REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
A	M101143	ADDED "gk" PIN CONNECTION, TT100 CASE STYLE & NOTE 2	10/10/05	MMG	DJ
B	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL
C	M108637	REMOVED "PIN 1" , ADDED INDEX ON UNIT	12/01/06	MYG	FL

SUGGESTED MOUNTING CONFIGURATION FOR BH292, CD541/542/636/637, TT100/240 CASE STYLES, "gk", "ht", "hu", "nd", "w" PIN CONNECTIONS



NOTES:
1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	MMG	07/17/02
TOLERANCES ON:	CHECKED	WL	08/02/02
2 PL DECIMALS ±	APPROVED	DJ	08/05/02
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

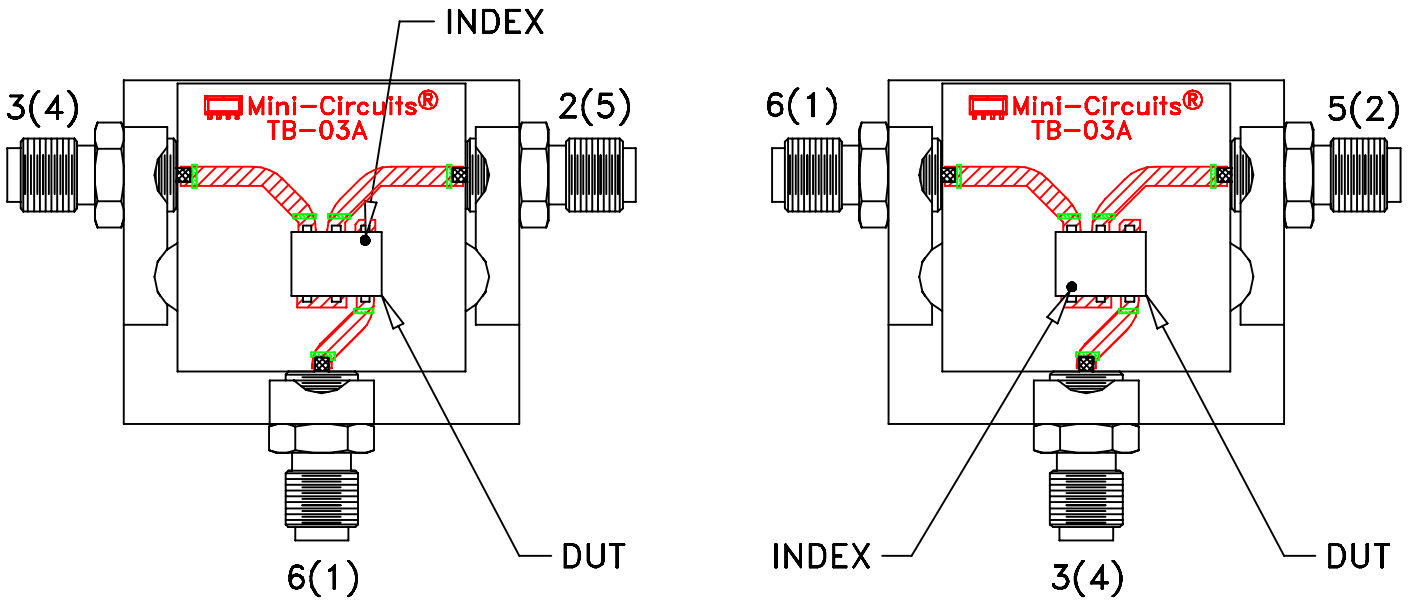
PL, gk/ht/hu/nd/w, BH292, CD541/542/636/637, TT100/240, TB-03

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-052	C

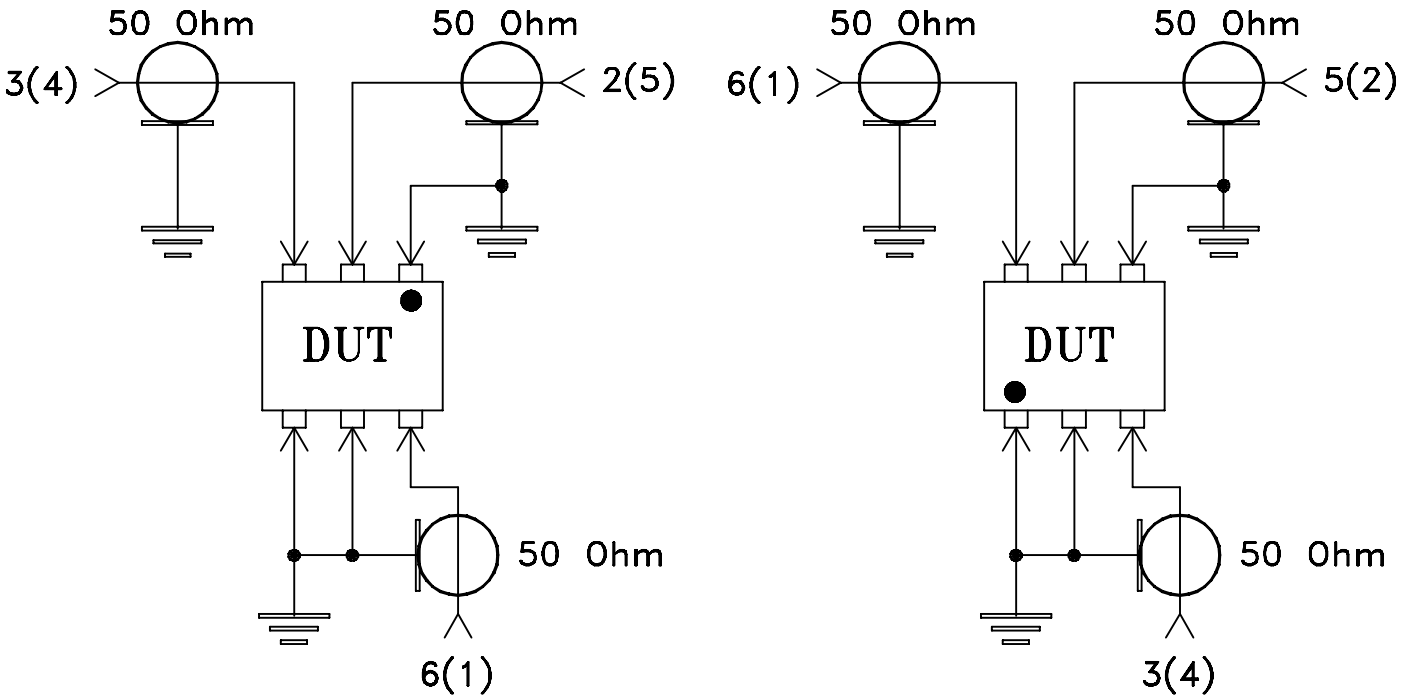
FILE:	SCALE:	SHEET:
98PL052	8:1	1 OF 1

Evaluation Board and Circuit

For Pin Connections and DUT Orientation Refer to Data Sheet of the DUT



TB-03



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

Mini-Circuits®

Mini-Circuits

Environmental Specifications ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215